

P-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

BV _{DSS}	R _{DS(ON)} Max	I _D Max T _C = +25°C
201/	32mΩ @ V _G S = -4.5V	-15A
-20V	$53\text{m}\Omega$ @ V_{GS} = -2.5V	-12A

Features

- 0.6mm Profile Ideal for Low-Profile Applications
- PCB Footprint of 4mm²
- Low Gate Threshold Voltage
- Low On-Resistance
- Wettable Flank for Improved Optical Inspection
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

Description and Applications

This new generation MOSFET is designed to minimize the on-state resistance (RDS(ON)) yet maintain superior switching performance, making it ideal for high-efficiency power-management applications.

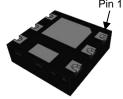
- Power-management functions
- General-purpose interfacing switches

Mechanical Data

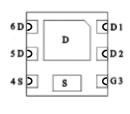
- Package: U-DFN2020-6
- Package Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish NiPdAu over Copper Leadframe. Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.0065 grams (Approximate)



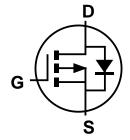




Bottom View



Pinout **Bottom View**



Equivalent Circuit

Ordering Information (Note 4)

Orderable Part Number	Package	Pac	king
Orderable Part Number	Package	Qty.	Carrier
DMP2040UFDFW-7	U-DFN2020-6/SWP (Type UXG)	3,000	Tape & Reel
DMP2040UFDFW-13	U-DFN2020-6/SWP (Type UXG)	10,000	Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.



Marking Information

DMP2040UFDFW-7 DMP2040UFDFW-13



U4 = Product Type Marking Code YWX = Date Code Marking Y = Year (ex: 5 = 2025)

Y = Year (ex: 5 = 2025) W = Week (ex: a = Week 27; z Represents Week 52 and 53)

X = Internal Code (ex: U = Monday)

Date Code Key

Year	2024	2025	2026	2027	2028	2029	2030	2031	2032	2033	2034	2035
Code	4	5	6	7	8	9	0	1	2	3	4	5

Week	1-26	27-52	53
Code	A-Z	a-z	Z

Internal Code	Sun	Mon	Tue	Wed	Thu	Fri	Sat
Code	Т	U	V	W	Х	Υ	Z

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage	VDSS	-20	V		
Gate-Source Voltage	Vgss	±12	V		
Continuous Drain Current (Note 5) V _{GS} = -4.5V	Steady State	$T_A = +25$ °C $T_A = +70$ °C	lD	-6.1 -4.9	А
Continuous Drain Current (Note 6) V _{GS} = -4.5V	ID	-15 -12	А		
Pulsed Drain Current (10µs Pulse, Duty Cycle =	1%)		IDM	-39	Α
Maximum Body Diode Continuous Current (Note	Is	-2.0	Α		
Avalanche Current (Note 7) L = 0.1mH		I _{AS}	-20	Α	
Avalanche Energy (Note 7) L = 0.1mH			Eas	21	mJ

Thermal Characteristics

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 8)	$T_A = +25$ °C	PD	1.1	W
Thermal Resistance, Junction to Ambient (Note 8)	Steady State	$R_{\theta JA}$	108	°C/W
Total Power Dissipation (Note 5)	T _A = +25°C	PD	1.8	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	68	°C/W
Thermal Resistance, Junction to Case (Note 6)	Steady State	Rejc	11	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Notes:

- $5. \ \, \text{Device mounted on FR-4 substrate PC board, 2oz copper, with 1 inch square copper plate}. \\$
- 6. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 7. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$.
- 8. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BVDSS	-20	_	_	V	Vgs = 0V, ID = -250µA	
Zero Gate Voltage Drain Current T _J = +25°C	IDSS			-1	μΑ	V _{DS} = -16V, V _{GS} = 0V	
Gate-Source Leakage	Igss			±100	nA	Vgs = ±12V, Vps = 0V	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	Vgs(th)	-0.6	_	-1.5	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
Static Drain-Source On-Resistance	D		27	32	O	$V_{GS} = -4.5V, I_{D} = -8.9A$	
Static Drain-Source On-Resistance	R _{DS(ON)}	_	38	53	mΩ	$V_{GS} = -2.5V, I_{D} = -6.9A$	
Diode Forward Voltage	VsD	_	-0.7	-1.2	V	VGS = 0V, IS = -2.9A	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	C _{iss}		834	_	pF	401/1/	
Output Capacitance	Coss		133	_	pF	$V_{DS} = -10V, V_{GS} = 0V$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	105	_	pF	1 = 1.000112	
Gate Resistance	Rg	_	4.9	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$	
Total Gate Charge (V _{GS} = -4.5V)	Q_g		8.6	_	nC		
Total Gate Charge (V _{GS} = -8V)	Qg		19	_	nC	V _{DS} = -6V. I _D = -8.9A	
Gate-Source Charge	Qgs		1.5	_	nC	VDS = -6V, ID = -6.9A	
Gate-Drain Charge	Q_{gd}	_	2.5	_	nC		
Turn-On Delay Time	t _{D(ON)}	_	5.8	_	ns		
Turn-On Rise Time	t _R	_	7.7	_	ns	$V_{DD} = -6V$, $R_L = 6\Omega$	
Turn-Off Delay Time	tD(OFF)	_	28.1	_	ns	$V_{GS} = -4.5V$, $R_g = 6\Omega$, $I_D = -1A$	
Turn-Off Fall Time	t _F	_	14.6	_	ns		
Reverse-Recovery Time	t _{RR}	_	9.8	_	ns	I= 0.00 di/dt 1000//:-	
Reverse-Recovery Charge	Q _{RR}	_	2.7	_	nC	IF = -8.9A, di/dt = -100A/μs	

Notes:

^{9.} Short duration pulse test used to minimize self-heating effect. 10. Guaranteed by design. Not subject to product testing.



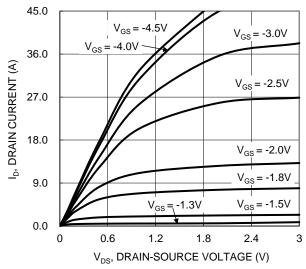


Figure 1. Typical Output Characteristic

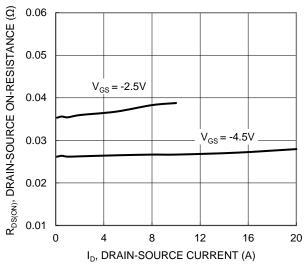


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

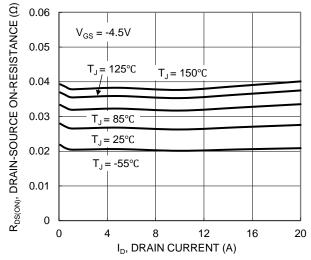


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature

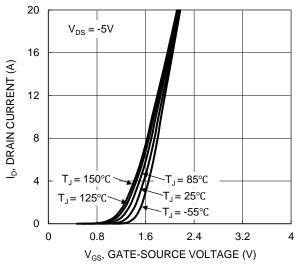


Figure 2. Typical Transfer Characteristic

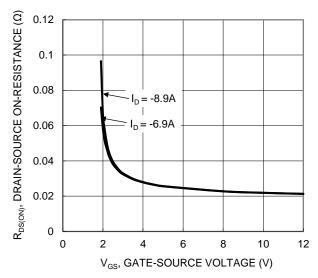


Figure 4. Typical Transfer Characteristic

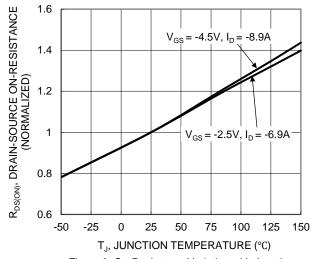


Figure 6. On-Resistance Variation with Junction Temperature



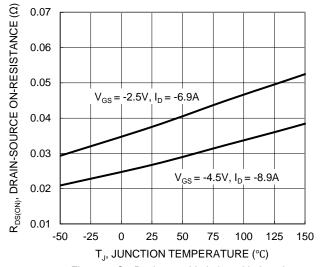


Figure 7. On-Resistance Variation with Junction Temperature

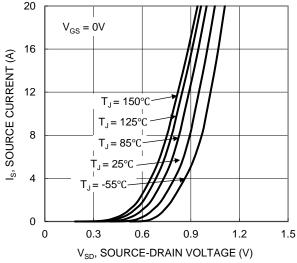


Figure 9. Diode Forward Voltage vs. Current

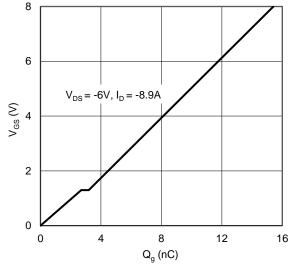


Figure 11. Gate Charge

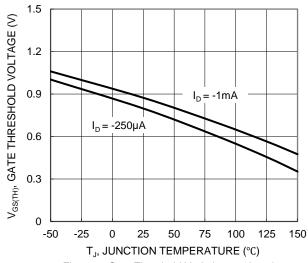


Figure 8. Gate Threshold Variation vs. Junction Temperature

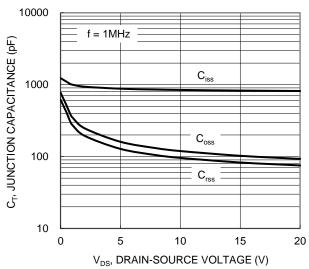


Figure 10. Typical Junction Capacitance

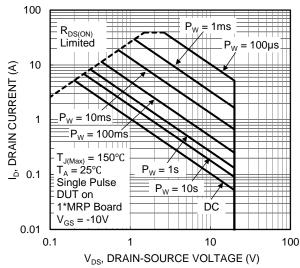


Figure 12. SOA, Safe Operation Area



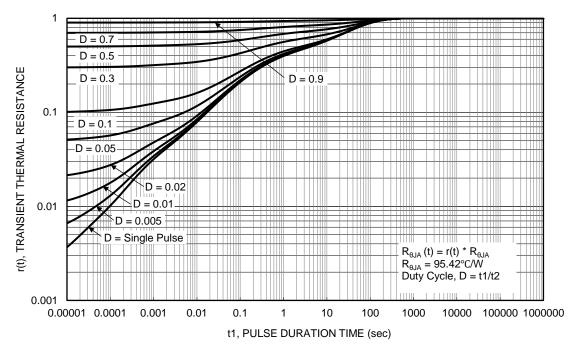


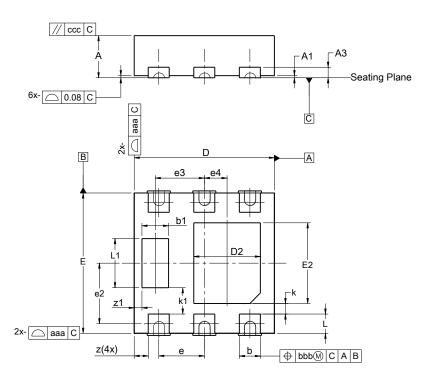
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6/SWP (Type UXG)

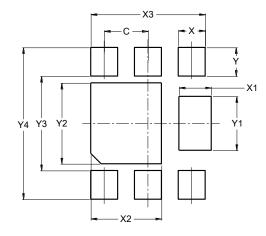


U-DFN2020-6/SWP						
		UXG)				
Dim	Min	Max	Тур			
Α	0.59	0.65	0.62			
A1	0.00	0.05	0.03			
A3			0.152			
b	0.28	0.38	0.33			
b1	0.35	0.45	0.40			
D	1.95	2.05	2.00			
D2	0.87	1.07	0.97			
Е	1.95	2.05	2.00			
E2	1.07	1.17				
е	0.65 BSC					
е3		0.70 BSC				
e4	0	.325 BS	С			
L	0.225	0.325	0.275			
L1	0.67	0.77	0.72			
k			0.15			
k1			0.375			
z			0.20			
z1			0.11			
aaa		0.25				
bbb		0.10				
CCC		0.10				
All	Dimens	ions in	mm			

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

U-DFN2020-6/SWP (Type UXG)



Dimensions	Value (in mm)
С	0.650
Х	0.350
X1	0.480
X2	1.050
Х3	1.700
Y	0.425
Y1	0.800
Y2	1.200
Y3	1.400
Y4	2.250



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